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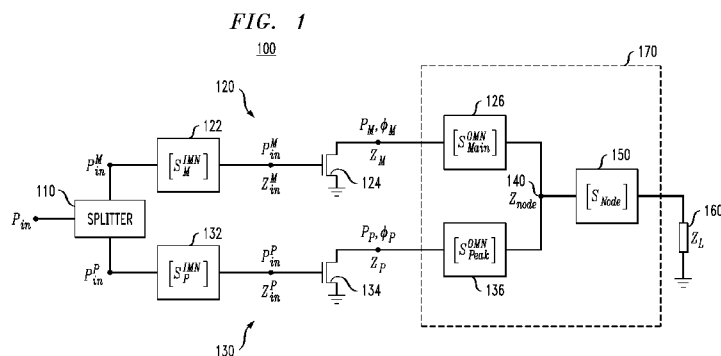
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- (54) **Title:** DESIGN AND ANALYSIS OF DOHERTY AMPLIFIERS



(57) **Abstract:** An analysis technique for (Doherty) amplifiers having a main amplifier branch and at least one peak amplifier branch. For a given input power level and assumed amplifier impedance levels, an output power level and phase response are obtained for each active device using appropriate load-pull data based on the impedance levels. The performance of the amplifier is analyzed based on the impedance levels, output power levels, and phase responses to generate updated impedance levels. The analysis is repeated until the updated impedance levels converge on steady state values. The analysis can be repeated for different input power levels. Main and peak output matching networks for the amplifier can be designed by iteratively adjusting impedance levels for the networks using appropriate load-pull contours. For the design and analysis phases, the load-pull contours include Class-AB data for the main amplifier device and Class-C data for the peak amplifier device.

DESIGN AND ANALYSIS OF DOHERTY AMPLIFIERS

BACKGROUND

Field

5 The present invention relates to electronics and, more specifically but not exclusively, to Doherty amplifiers.

Description of the Related Art

10 This section introduces aspects that may help facilitate a better understanding of the invention(s). Accordingly, the statements of this section are to be read in this light and are not to be understood as admissions about what is in the prior art or what is not in the prior art.

15 A Doherty amplifier has a main amplifier branch and one or more peak amplifier branches that are designed to enable the amplifier to provide high-power amplification by supplementing the amplification provided by the main branch during peak power operations. During normal power operations, the peak branches may be disabled such that high-efficiency amplification is provided by only the main branch. Doherty amplifiers are used in high-capacity wireless systems having modulated signals that exhibit high peak-to-average power ratios.

20 Certain conventional design practices for Doherty amplifiers rely on Class-AB load-pull data and/or non-linear models in circuit simulators to characterize active devices. The design process is mainly based on manual calculations derived from Doherty design principles and limited load-pull data. Designers make many assumptions such as what input power split to use, which impedance modulation ratio to use, and which gain and
25 compression values to use for each device. Such assumptions might not be accurate and may cause large discrepancies between expected and achieved performance characteristics of the resulting Doherty amplifier, leading to missed milestone deadlines and lower performance capabilities of the amplifier. The deviations from the desired performance are discovered only after the first prototypes are built and tested, at which point it is usually too
30 late to make major changes to fix problems caused by faulty assumptions. Deviations that can be fixed involve manual tuning on the bench, which is a costly, time-consuming, and laborious process with no guarantees of success. Since the tuning is done on a small sample of prototypes, there is no guarantee that the solution will be optimal for large-scale production.

BRIEF DESCRIPTION OF THE DRAWINGS

Other aspects, features, and benefits of various embodiments of the invention will become more fully apparent, by way of example, from the following detailed description and the accompanying drawings, in which:

FIG. 1 shows a block diagram of a fixed-input-conditioning, power-split, two-way Doherty amplifier having a main amplifier branch and a peak amplifier branch;

FIG. 2 shows a generic matching network configured between a grounded input load and a grounded output load;

10 FIG. 3 shows a generic matching network;

FIG. 4 shows a flow diagram of technique for designing the two-way Doherty amplifier of FIG. 1;

FIG. 5 shows a flow diagram of a technique for analyzing the two-way Doherty amplifier of FIG. 1; and

15 FIG. 6 shows a block diagram representing the passive output combining network of the two-way Doherty amplifier of FIG. 1.

DETAILED DESCRIPTION

Two-Way Doherty Amplifier

20 FIG. 1 shows a block diagram of a fixed-input-conditioning, power-split, two-way Doherty amplifier **100** having a main amplifier branch **120** and a peak amplifier branch **130**. Input conditioning refers to the control over amplitude and phase of input signals to each branch of the Doherty amplifier. Fixed input conditioning implies that the amplitude ratio of input signals and their phase relationship are adjusted for one power level at a single
25 frequency, e.g., by means of a hardware RF splitter and an input phase offset line. There is no ability to do any input adjustments over power and frequency range.

Main amplifier branch **120** consists of a cascade of a main input matching network **122**, a main amplifier device (e.g., transistor) **124**, and a main output matching network **126**, while peak amplifier branch **130** consists of a cascade of a peak input matching network
30 **132**, a peak amplifier device (e.g., transistor) **134**, and a peak output matching network **136**. An input signal is applied to an input power splitter **110**, which splits the input signal power according to a fixed ratio between the main amplifier branch **120** and the peak amplifier branch **130**. Output signals from the main and peak amplifier branches are combined at

combining node **140** where branches **120** and **130** meet, and the resulting combined signal is delivered to the output load **160** through node matching network **150**.

For low signal power operation, peak amplifier branch **130** is inactive (e.g., this is achieved by biasing peak device **134** in Class-C), such that all amplification is provided by main amplifier branch **120**. During high signal power operation, peak amplifier branch **130** is active (e.g., the signal amplitude is large enough to turn on peak amplifier device **134**), such that amplification is provided by both main amplifier branch **120** and peak amplifier branch **130**. The intended intermittent operation of the peak amplifier device **134** is achieved by operating it as a Class-C amplifier, while main amplifier device **124** functions as a Class-AB amplifier. The goal is to maximize efficiency of operation, which means bias should be minimized wherever possible. To achieve higher efficiency, some of the maximum linearity of operation of Class-A mode is traded off for efficiency by going to Class-AB mode. The tradeoff could be anywhere between Class-A and Class-B. Hence, Class-AB which can vary from very close to Class-A to very close to Class-B. This is a designer's choice.

The transfer function of each of the five matching networks **122**, **126**, **132**, **136**, and **150** may be represented by an S matrix that transforms complex incident voltages into complex reflected voltages according to Equation (1) as follows:

$$\begin{bmatrix} V_1^- \\ V_2^- \end{bmatrix} = \begin{bmatrix} S_{11} & S_{12} \\ S_{21} & S_{22} \end{bmatrix} \begin{bmatrix} V_1^+ \\ V_2^+ \end{bmatrix}$$

(1)

where V_1^+ and V_2^+ are the complex voltage waves incident on ports 1 and 2, respectively, V_1^- and V_2^- are the complex voltage waves reflected from ports 1 and 2, respectively, and S_{ij} are the four S-matrix parameters. From these voltages and S-parameters, the relevant impedances can be derived for matching networks **122**, **126**, **132**, **136**, and **150**, and vice-versa.

Design of a Two-Way Doherty Amplifier

The design of two-way Doherty amplifier **100** of FIG. 1 focuses on three main regions of the architecture: input power splitter **110**, main and peak output matching networks **126** and **136**, and node matching network **150**. The output combining network **170** (consisting of the main, peak, and node matching networks **126**, **136**, and **150**) is designed based on the combining node impedance modulation ratio N_{comb} , which is a

function of the maximum power delivered by the main and peak branches. The impedance modulation ratios are selected using the high-compression main and peak amplifier device load-pull contours (for example, 3dB for the main device and 1dB for the peak device) in order to realize the given specification of maximum output power requirements. The designer will select an appropriate value for the impedance modulation ratio based on power and efficiency specifications. The value is not uniquely determined and could have any value in the range from about 1.5 to about 4; however, values from about 2 to about 3 will have practical application for use with actual devices. Since the main and peak devices operate under different bias conditions, they will have different gains at different power levels.

The input power splitter **110** is designed to provide input power for each device to produce output power levels that will achieve the impedance modulation range for which the node matching network was designed. Because the peak device **134**, which is biased in Class-C mode of operation, has a lower gain than the main device **124**, and because the impedance modulation ratio may need to be greater than 2 for the amplifier to satisfy the efficiency requirement at an output power level that is backed off from the amplifier's maximum power, the input power splitter **110** generally provides unequal power splitting that steers more input power toward the peak device. The ratio of input peak power P_{IN}^P and input main power P_{IN}^M is determined from (i) the maximum power provided by the main device P_{OUT}^M , (ii) the corresponding main device gain G^M , (iii) the maximum power provided by the peak device P_{OUT}^P , and (iv) the corresponding peak device gain G^P , according to Equation (2a) as follows:

$$\frac{P_{IN}^P}{P_{IN}^M} = \frac{\frac{P_{OUT}^P}{G^P}}{\frac{P_{OUT}^M}{G^M}} = \frac{G^M P_{OUT}^P}{G^P P_{OUT}^M}.$$

(2a)

To design two-way Doherty amplifier **100** of FIG. 1, (at least) three sets of load-pull contours are used at each frequency of interest. For the main device **124**, two sets of constant-compression load-pull contours are used, for example, high-compression (3dB compression or higher) load-pull contours for selection of high-power impedance and low-

compression (circa 1dB compression) load-pull contours for high-efficiency impedance that are obtained for the main device operating under Class-AB bias conditions.

Each set of constant-compression contours has an impedance that has the highest power and an impedance that has the highest efficiency of all other impedances in the set. A
5 high-compression (3dB or higher) set is used to select a high-power impedance, and a low-compression (1dB or so) set is used to select a high-efficiency impedance. The high-efficiency impedance will have a lower power associated with it; whereas, the high-power impedance may have lower efficiency associated with it. 1dB compression is lower compression than 3dB. The main device is presented with high-efficiency/low-power
10 impedance until it reaches 1dB compression; at which point, the peak branch turns on and starts modulating the load impedance of the main branch from the high-efficiency/low-power point toward the high-power impedance point, while increasing the compression of the main device which will eventually end in high-power impedance in 3dB compression (or higher) contours. For the peak device **134**, one set of constant-compression load-pull
15 contours obtained under Class-C bias conditions is used, for example, high-power, 1dB-compression contours, as well as measurement of the off-state impedance of peak device **134** for average-power operations during which peak device **134** is disabled. Because a Class-C device has lower gain, it will undergo lower compression. For the case of the peak device, 1dB compression can be considered high compression. The compression is the
20 amount of gain decrease from the maximum level. Since the peak device has lower maximum gain due to its Class-C bias, it cannot be compressed too much before its gain becomes inadequate. Hence, 1dB compression is considered high for the peak device. P1dB is the power under 1dB gain compression. XdB refers to gain compression, and PXdB refers to power delivered under that compression. XdB is used when referring to
25 constant compression contours, and PXdB is used when refereeing to specific power within those contours. These three load-pull contours are obtained by measuring the devices that will be used in the actual amplifier design as the main and peak devices **124** and **134**.

Load-pull data is obtained for the devices that will be used in the amplifier design and construction. The devices are measured under the same (or similar) biasing and power
30 conditions under which they are intended to be used. The load-pull data consists of input power sweeps done for each load impedance presented to the device. The load-pull setup consists of a vector signal generator, source impedance transformer (e.g., source tuner + device input fixture), the device under test (e.g., transistor), load impedance transformer (e.g., load tuner + device output fixture), and vector signal receiver. A set of load

impedances for the test is selected. Several trial measurements may be needed to determine the optimal set of load impedances. Once the device is biased to obtain desired operating conditions, for every load impedance presented to the device by the load impedance transformer, the input power is swept over a prescribed range, and various performance parameters of the transistor are recorded (e.g., output power, gain, efficiency, AM-PM, insertion phase, drain current, etc.). The measurements have the following nesting:

Set bias

Set frequency

Set load impedance

10 Sweep input power and collect measured data

Next load impedance

Next frequency

Next bias

The measurements are taken for various biasing conditions (Class-AB, Class-B, Class-C of various depths). The measurements are often done for more than one frequency to get better characterization over frequency. The measured data provides the relationship between input and the output of the active device under various loading conditions, such as those that occur in the Doherty amplifier where two branches interact at the node. The data allows us to calculate the response from the transistor based on the interactions of the branch signals at the combining node which are power dependent. The data obtained at each frequency of interest is used to characterize amplifier performance at that frequency. For each load impedance, the device (keeping the same input power conditions) will have different performance regarding output power, gain, and efficiency. Based on the specification, the designer needs to select impedances that will yield performance sufficient to meet the amplifier specifications. Load-pull data allows the designer to pick an impedance that satisfies the high-power requirement for the main device, an impedance that satisfies the high-efficiency requirement at power back-off for the main device, as well as an impedance that satisfies the high-power requirement for one or more peak devices. In the design synthesis procedure, the load-pull data are plotted in constant-compression contour format to facilitate the visual selection of the impedances. This is similar to topographical maps with constant elevation contours, where it becomes easy to locate mountain peaks or plateaus. In the analysis procedure, the load-pull data are plotted in constant-input-power contour format to facilitate location of new impedances that result from convergence calculations in the passive circuit part of the network (main matching network, peak

matching network, node matching network). Once the designer makes the impedance selection based on amplifier specifications and subject to restrictions imposed by the synthesis algorithm (to ensure that the solution can be implemented), the analysis algorithm will calculate the response of the amplifier that results from the designer's selections.

- 5 The impedance modulation ratio N_{comb} of output combining network **170** determines the range of impedances $Z_{node} \leq Z_{LM} \leq N_{comb}Z_{node}$ that will load the main output matching network **126**, where Z_{node} is the impedance at combining node **140** looking towards node matching network **150**, and Z_{LM} is the load impedance of the main branch **120**, which varies between Z_{node} and $N_{comb}Z_{node}$ as input power P_{in} varies. The combining-network impedance modulation ratio N_{comb} is defined according to Equation (2b) as follows:

$$N_{comb} = \frac{P_p^M + P_p^P}{P_p^M},$$

(2b)

- where P_p^M is the maximum output power of the main device **124** and P_p^P is the maximum output power of the peak device **134**. P_p^M comes from the high-compression (3dB or higher usually) main device load-pull contours, while P_p^P comes from the high-compression (0.3dB to 1dB or so) peak device load-pull contours.

- The value of the combining-network impedance modulation ratio N_{comb} is affected by the selection of the high-power, main impedance Z_{MP} using the main-device, 3dB (high-compression) load-pull contours and by the selection of the high-power peak impedance Z_{PP} using the peak-device 1dB (high-compression) load-pull contours, because the selection of these impedances will change the amount of power delivered by the devices.

In addition, using the main-device 1dB (low-compression) load-pull contours, the high-efficiency main impedance Z_{ME} is selected to satisfy the efficiency requirement at the power back-off level.

- 25 After both impedances Z_{ME} and Z_{MP} are selected using the main-device load-pull contours, the impedance modulation ratio N_{LP} of the main device **124** can be calculated according to Equation (3) as follows:

$$N_{LP} = \frac{1+|\Gamma|}{1-|\Gamma|},$$

(3)

where:

$$|\Gamma| = \left| \frac{\Gamma'_{ME} - \Gamma'_{MP}}{1 - \Gamma_{MP} \Gamma'_{ME}} \right|,$$

(4)

where the prime symbol (') represents complex conjugation, and the symbol Γ_{xx} represents
 5 the voltage reflection coefficient, which is related to the impedance Z_{xx} by Equation (5) as follows:

$$\Gamma_{xx} = \frac{Z_{xx} - Z_0}{Z_{xx} + Z_0},$$

(5)

where Z_0 is the system reference impedance (usually 50Ω).

10 Thus, the voltage reflection coefficient Γ_{MP} corresponding to the main-device, high-power impedance Z_{MP} selected using the main-device, 3dB (high-compression) load-pull contours is given by $\Gamma_{MP} = \frac{Z_{MP} - Z_0}{Z_{MP} + Z_0}$. Similarly, the voltage reflection coefficient Γ_{ME} corresponding to the main-device, high-efficiency impedance Z_{ME} selected using the main-device, P1dB (low-compression) load-pull contours is given by $\Gamma_{ME} = \frac{Z_{ME} - Z_0}{Z_{ME} + Z_0}$.

15 The main-device impedance modulation ratio N_{LP} is related to the range of impedances presented to the main device **124** and depends on the choice of the high-power and high-efficiency main-device impedances Z_{MP} and Z_{ME} , but is independent from the high-power peak-device impedance Z_{pp} .

To design an amplifier that will yield targeted performance, impedances Z_{MP} , Z_{pp} ,
 20 and Z_{ME} cannot be selected independently. Rather, the selections of impedances are such that the condition $N_{LP} = N_{comb}$ is satisfied. That is, $N_{LP} = \frac{1 + |\Gamma|}{1 - |\Gamma|} = \frac{P_p^M + P_p^P}{P_p^M} = N_{comb} = N$. If not, the amplifier will still work, but achieved performance might deviate from the targeted values.

Based on the condition $N_{LP} = N_{comb}$, the S matrices for the matching networks **126**,
 25 **136**, and **150** in the output combining network **170** can be calculated. The S matrices will be calculated for impedance values selected even if the $N_{LP} = N_{comb}$ condition is not

satisfied. The designer can see the consequences of this choice by running the analysis part and then decide whether to alter the design or keep it as is. After establishing the input power split ratio, the impedance modulation ratio, and the values of impedances Z_{MP} , Z_{PP} , and Z_{ME} , we can proceed with (i) the design of the input power splitter **110**, the main and peak input matching networks **122** and **132**, the main and peak output matching networks **126** and **136**, and the node matching network **150** and (ii) the determination of the delay compensation for the phase difference between the two branches.

Generic Matching Network

FIG. 2 shows a generic matching network **220** configured between (i) a grounded input load **210** having impedance Z_S and voltage reflection coefficient Γ_S and (ii) a grounded output load **230** having impedance Z_L and voltage reflection coefficient Γ_L . The input and output voltage reflection coefficients Γ_{IN} and Γ_{OUT} for generic matching network **220** are given by Equations (6) and (7), respectively, as follows:

$$\Gamma_{IN} = S_{11} + \frac{S_{12}S_{21}\Gamma_L}{1 - S_{22}\Gamma_L} \quad (6)$$

and

$$\Gamma_{OUT} = S_{22} + \frac{S_{12}S_{21}\Gamma_S}{1 - S_{11}\Gamma_S}, \quad (7)$$

where S_{11} , S_{12} , S_{21} , and S_{22} are the parameters of the S matrix for generic matching network **220**.

S Matrix for Input Matching Networks and Node Matching Network

Since each of the main and peak input matching networks **122** and **132** and the node matching network **150** converts the system reference impedance Z_0 (usually 50Ω) to an arbitrary known impedance, the calculations for these three networks can be done the same way.

Main input matching network **122** converts the output impedance of the main branch of the splitter **110** (usually Z_0) to a known source impedance Z_{SM} to be presented to the gate of main device **124**. Note that the source impedance Z_{SM} is the impedance looking into

main input matching network **122** from the main device **124**, whereas the impedance Z_{in}^M of FIG. 1 is the impedance looking into the main device **124** from network **122**. This source impedance Z_{SM} is known from the load-pull data, so the impedance conversion of main input matching network **122** is from Z_0 to Z_{SM} .

5 Peak input matching network **132** converts the output impedance of the peak branch of the splitter **110** (usually Z_0) to a known source impedance Z_{SP} to be presented to the gate of peak device **134**. Note that the source impedance Z_{SP} is the impedance looking into peak input matching network **132** from the peak device **134**, whereas the impedance Z_{in}^P of FIG. 1 is the impedance looking into the peak device **134** from network **132**. This source
10 impedance Z_{SP} is known from the load-pull data, so the impedance conversion of peak input matching network **132** is from Z_0 to Z_{SP} .

Going in the opposite direction, node matching network **150** converts a known output load impedance Z_L (usually Z_0) to a known calculated node impedance Z_{node} at combining node **140**.

15 In essence, the process is the same for all three matching networks; only the target impedance changes (Z_{SM} , Z_{SP} , and Z_{node}). In reference to FIG. 2, the output load impedance Z_L of FIG. 2 always corresponds to Z_0 (i.e., splitter output impedances and output load **160** of FIG. 1), and Z_{IN} related to Γ_{IN} of FIG. 2 always corresponds to Z_{SM} , Z_{SP} at the respective device gate and Z_{node} at combining node **140** of FIG. A. Thus, for the
20 main and peak input matching networks **122** and **132**, the output load **230** of FIG. 2 corresponds to the upstream, splitter side of the network, while, for the node matching network **150**, the output load **230** corresponds to output load **160** of FIG. 1 at the downstream side of the network.

For an output load impedance Z_L equal to the system reference impedance Z_0 , the
25 load voltage reflection coefficient $\Gamma_L = 0$. Substituting $\Gamma_L = 0$ into Equation (6) yields Equation (8) as follows:

$$S_{11} = \Gamma_{IN}.$$

(8)

In other words, the parameter S_{11} will be equal to the input voltage reflection coefficient Γ_{IN}
30 , which is known from the load-pull data.

In the case of complex conjugate match, $\Gamma_s = \Gamma_{IN}'$ and $\Gamma_{OUT} = 0$, where the prime (') indicates complex conjugation. The case of complex conjugate match is the condition that maximizes the power transfer, but other conditions can be used. In those other cases, Γ_s and Γ_{OUT} will be specified differently but the rest of the calculation is done in the same way with results that will reflect changes in the specification of Γ_s and Γ_{OUT} . Applying the equivalences $\Gamma_s = \Gamma_{IN}'$ and $\Gamma_{OUT} = 0$ to Equation (7) yields Equation (9) as follows:

$$\Gamma_{OUT} = S_{22} + \frac{S_{21}S_{12}\Gamma_s}{1 - S_{11}\Gamma_s} = S_{22} + \frac{S_{21}S_{12}\Gamma_{IN}'}{1 - \Gamma_{IN}\Gamma_{IN}'} = S_{22} + \frac{S_{21}S_{12}\Gamma_{IN}'}{1 - |\Gamma_{IN}|^2} = 0. \quad (9)$$

Solving Equation (9) for S_{22} yields Equation (10) as follows:

$$S_{22} = -\frac{S_{21}S_{12}\Gamma_{IN}'}{1 - |\Gamma_{IN}|^2}. \quad (10)$$

Since the S matrix for a lossless, passive circuit is unitary, $[S']^T = [S]^{-1}$. In other words, the transpose of the complex conjugate of a unitary S matrix will be equal to the inverse of that S matrix. Since the product of an S matrix and its inverse is equal to the identity matrix, multiplying $[S']^T = [S]^{-1}$ from the left by $[S]$ yields Equation (11) as follows:

$$\begin{bmatrix} S_{11} & S_{12} \\ S_{21} & S_{22} \end{bmatrix} \begin{bmatrix} S_{11}' & S_{21}' \\ S_{12}' & S_{22}' \end{bmatrix} = \begin{bmatrix} 1 & 0 \\ 0 & 1 \end{bmatrix}. \quad (11)$$

Expanding Equation (11) yields Equations (12)-(15) as follows:

$$|S_{11}|^2 + |S_{12}|^2 = 1, \quad (12)$$

$$S_{11}S_{21}' + S_{12}S_{22}' = 0, \quad (13)$$

$$S_{11}'S_{21} + S_{12}'S_{22} = 0, \quad (14)$$

$$|S_{21}|^2 + |S_{22}|^2 = 1. \quad (15)$$

Since the matching networks are reciprocal, $S_{21} = S_{12}$. Applying this equality and Equations (8) and (12) yields Equation (16) as follows:

$$|S_{21}|^2 = |S_{12}|^2 = |S_{21}S_{12}| = 1 - |S_{11}|^2 = 1 - |\Gamma_{IN}|^2.$$

(16)

5 Equation (16) implies Equation (17) as follows:

$$S_{21}S_{12} = |S_{21}S_{12}|e^{j\phi} = (1 - |\Gamma_{IN}|^2)e^{j\phi},$$

(17)

where ϕ is the phase of the complex value, which is a function of the network "length," which is related to the phase and time delay of the signals propagating through the network.

10 Higher insertion phase is associated with longer delay. Since $S_{21} = S_{12}$, Equation (17) implies Equation (18) as follows:

$$S_{12} = S_{21} = \sqrt{1 - |\Gamma_{IN}|^2} e^{j\frac{\phi}{2}}.$$

(18)

Substituting Equation (17) into Equation (10) yields Equation (19) as follows:

$$15 \quad S_{22} = -\frac{S_{21}S_{12}\Gamma'_{IN}}{1 - |\Gamma_{IN}|^2} = -\frac{(1 - |\Gamma_{IN}|^2)e^{j\phi}\Gamma'_{IN}}{1 - |\Gamma_{IN}|^2} = -\Gamma'_{IN}e^{j\phi}.$$

(19)

Thus, for each of main input matching network **122**, peak input matching network **132**, and node matching network **150**, the corresponding S matrix parameters S_{11} , S_{12} , S_{21} , and S_{22} are given in terms of the input voltage reflection coefficient Γ_{IN} by Equations (8),
 20 (18), and (19), where Γ_{IN} is known from the load-pull data. The phase ϕ is arbitrary. It can be minimized, and it needs to be equalized between the main and peak branches. Also, the phase of the peak branch can be used to ensure that currents from the main and peak branches combine at the combining node **140** in phase.

25 S Matrix for Main Output Matching Network

The S matrix S^M for the main output matching network **126** is given by Equation (20) as follows:

$$S^M = \begin{bmatrix} S_{11}^M & S_{12}^M \\ S_{21}^M & S_{22}^M \end{bmatrix}$$

(20)

During high-power operations, going from the combining node **140** toward the main device **124**, the main output matching network **126** converts the high-power main load impedance Z_{LMP} into the high-power main-device impedance Z_{MP} . During high-efficiency operations, going from the combining node **140** toward to the main device **124**, the main output matching network **126** converts the high-efficiency main load impedance Z_{LME} into the high-efficiency main-device impedance Z_{ME} . The main-device impedances Z_{MP} and Z_{ME} are known from the load-pull data selections, the high-power main load impedance Z_{LMP} is user determined (usually Z_0), and the high-efficiency main load impedance

$$Z_{LME} = Z_{LMP} / N_{comb}.$$

According to Equation (5), respective voltage reflection coefficients Γ_{LMP} , Γ_{LME} , Γ_{MP} , and Γ_{ME} for the four impedances Z_{LMP} , Z_{LME} , Z_{MP} , and Z_{ME} can be calculated by Equations (21)-(24) as follows:

$$\Gamma_{LMP} = \frac{Z_{LMP} - Z_0}{Z_{LMP} + Z_0},$$

(21)

$$\Gamma_{LME} = \frac{Z_{LME} - Z_0}{Z_{LME} + Z_0},$$

(22)

$$\Gamma_{MP} = \frac{Z_{MP} - Z_0}{Z_{MP} + Z_0},$$

(23)

$$\Gamma_{ME} = \frac{Z_{ME} - Z_0}{Z_{ME} + Z_0}.$$

20

(24)

Referring to FIG. 2, for the main output matching network **126**, for high-power operations:

$$\Gamma_L = \Gamma_{LMP},$$

25 (25)

$$\Gamma_S = \Gamma'_{MP},$$

(26)

14

$$\Gamma_{IN} = \Gamma_{MP}, \quad (27)$$

$$\Gamma_{OUT} = \Gamma'_{MLP}. \quad (28)$$

5 Substituting Equations (25) and (27) into Equation (6) yields Equation (29) as follows:

$$\Gamma_{MP} = S_{11}^M + \frac{S_{12}^M S_{21}^M \Gamma_{LMP}}{1 - S_{22}^M \Gamma_{LMP}}. \quad (29)$$

10 Similarly, substituting Equations (26) and (28) into Equation (7) yields Equation (30) as follows:

$$\Gamma'_{LMP} = S_{22}^M + \frac{S_{12}^M S_{21}^M \Gamma'_{MP}}{1 - S_{11}^M \Gamma'_{MP}}. \quad (30)$$

Referring to FIG. 2, for the main output matching network **126**, for high-efficiency operations:

$$15 \quad \Gamma_L = \Gamma_{LME}, \quad (31)$$

$$\Gamma_S = \Gamma'_{ME}, \quad (32)$$

$$20 \quad \Gamma_{IN} = \Gamma_{ME}, \quad (33)$$

$$\Gamma_{OUT} = \Gamma'_{LME}. \quad (34)$$

Substituting Equations (31) and (33) into Equation (6) yields Equation (35) as follows:

$$25 \quad \Gamma_{ME} = S_{11}^M + \frac{S_{12}^M S_{21}^M \Gamma_{LME}}{1 - S_{22}^M \Gamma_{LME}}. \quad (35)$$

Similarly, substituting Equations (32) and (34) into Equation (7) yields Equation (36) as follows:

15

$$\Gamma'_{LME} = S_{22}^M + \frac{S_{12}^M S_{21}^M \Gamma'_{ME}}{1 - S_{11}^M \Gamma'_{ME}}.$$

(36)

Subtracting Equation (35) from Equation (29) yields Equation (37) as follows:

$$\Gamma_{MP} - \Gamma_{ME} = S_{12}^M S_{21}^M \left(\frac{\Gamma_{LMP}}{1 - S_{22}^M \Gamma_{LMP}} - \frac{\Gamma_{LME}}{1 - S_{22}^M \Gamma_{LME}} \right).$$

5

(37)

Subtracting Equation (36) from Equation (30) yields Equation (38) as follows:

$$\Gamma'_{LMP} - \Gamma'_{LME} = S_{12}^M S_{21}^M \left(\frac{\Gamma'_{MP}}{1 - S_{11}^M \Gamma'_{MP}} - \frac{\Gamma'_{ME}}{1 - S_{11}^M \Gamma'_{ME}} \right).$$

(38)

Rearranging Equation (37) yields Equation (39) as follows:

$$S_{12}^M S_{21}^M = \frac{(\Gamma_{MP} - \Gamma_{ME})(1 - S_{22}^M \Gamma_{LMP})(1 - S_{22}^M \Gamma_{LME})}{\Gamma_{LMP} - \Gamma_{LME}}.$$

10

(39)

Substituting Equation (39) into Equation (29) and rearranging yields Equation (40)

as follows:

$$S_{11}^M = \Gamma_{MP} - \frac{(\Gamma_{MP} - \Gamma_{ME})(1 - S_{22}^M \Gamma_{LME}) \Gamma_{LMP}}{\Gamma_{LMP} - \Gamma_{LME}}.$$

15

(40)

Rearranging Equation (30) yields Equation (41) as follows:

$$S_{22}^M = \Gamma'_{LMP} - \frac{S_{21}^M S_{12}^M \Gamma'_{MP}}{1 - S_{11}^M \Gamma'_{MP}}.$$

(41)

Substituting Equations (39) and (40) into Equation (41) yields Equation (42) as

20 follows:

$$S_{22}^M = \Gamma'_{LMP} - \frac{(\Gamma_{MP} - \Gamma_{ME})(1 - S_{22}^M \Gamma_{LMP})(1 - S_{22}^M \Gamma_{LME}) \Gamma'_{MP}}{(\Gamma_{LMP} - \Gamma_{LME})(1 - |\Gamma_{MP}|^2) + (\Gamma_{MP} - \Gamma_{ME})(1 - S_{22}^M \Gamma_{LME}) \Gamma_{LMP} \Gamma'_{MP}}.$$

(42)

Solving Equation (42) for the matrix parameter S_{22}^M yields Equation (43) as follows:

$$S_{22}^M = \frac{|\Gamma_{LMP}|^2 - \Gamma'_{LMP} \Gamma_{LME} + |\Gamma_{MP}|^2 \Gamma'_{LMP} \Gamma_{LME} - |\Gamma_{LMP}|^2 \Gamma'_{MP} \Gamma_{ME} - |\Gamma_{MP}|^2 \Gamma'_{MP} \Gamma_{ME}}{\Gamma_{LMP} - \Gamma_{LME} - |\Gamma_{MP}|^2 |\Gamma_{LMP}|^2 \Gamma_{LME} - |\Gamma_{LMP}|^2 \Gamma'_{MP} \Gamma_{ME} \Gamma_{LME} - \Gamma_{LMP} |\Gamma_{MP}|^2 + \Gamma'_{MP} \Gamma_{ME} \Gamma_{LME}}.$$

(43)

Once the matrix parameter S_{22}^M is calculated using Equation (43) in terms of the voltage reflection coefficients Γ_{ME} , Γ_{MP} , Γ_{LMP} , and Γ_{LME} given by Equations (21)-(24), and assuming that the network is reciprocal such that $S_{21}^M = S_{12}^M$, the remaining matrix

5 parameters S_{11}^M , S_{12}^M , and S_{21}^M can be calculated using Equations (39) and (40).

S Matrix for Peak Output Matching Network

The S matrix S^P for the peak output matching network **136** is given by Equation (44) as follows:

$$S^P = \begin{bmatrix} S_{11}^P & S_{12}^P \\ S_{21}^P & S_{22}^P \end{bmatrix}$$

(44)

During high-power operations, going from the combining node **140** toward the peak device **134**, the peak output matching network **136** converts the high-power peak load impedance Z_{LPP} into the high-power peak-device impedance Z_{pp} . During high-efficiency operations in

15 which the peak device **134** is off, going from the peak device **134** to toward the combining node **140**, the peak output matching network **136** converts the peak-device off-state impedance Z_{POFF} into the off-state peak load impedance Z_{LPOFF} .

The high-power peak-device impedance Z_{pp} is known from the load-pull data selections. The high-power peak load impedance Z_{LPP} is a function of the user-selected,

20 high-power main load impedance Z_{LMP} (see previous section) and is given by Equation (45) as follows:

$$Z_{LPP} = Z_{LMP} / (N_{comb} - 1).$$

(45)

The peak-device off-state impedance Z_{POFF} is directly measured from the peak device **134**,

25 and the off-state peak load impedance Z_{LPOFF} is given by $Z_{LPOFF} = N_{OFF} Z_{POFF}$, where:

$$N_{OFF} = \frac{1 + |\Gamma|}{1 - |\Gamma|}$$

(46)

and

$$|\Gamma| = \left| \frac{\Gamma_{POFF} - \Gamma'_{PP}}{1 - \Gamma_{PP}\Gamma_{POFF}} \right|.$$

(47)

According to Equation (5), respective voltage reflection coefficients Γ_{LPP} , Γ_{LPOFF} , Γ_{PP} , and Γ_{POFF} for the four impedances Z_{LPP} , Z_{LPOFF} , Z_{PP} , and Z_{POFF} can be calculated by

5 Equations (48)-(51) as follows:

$$\Gamma_{LPP} = \frac{Z_{LPP} - Z_0}{Z_{LPP} + Z_0},$$

(48)

$$\Gamma_{LPOFF} = \frac{Z_{LPOFF} - Z_0}{Z_{LPOFF} + Z_0},$$

(49)

10

$$\Gamma_{PP} = \frac{Z_{PP} - Z_0}{Z_{PP} + Z_0},$$

(50)

$$\Gamma_{POFF} = \frac{Z_{POFF} - Z_0}{Z_{POFF} + Z_0}.$$

(51)

15 Referring to FIG. 2, for the peak output matching network **136**, for high-power operations:

$$\Gamma_L = \Gamma_{LPP},$$

(52)

$$\Gamma_S = \Gamma'_{PP},$$

(53)

20

$$\Gamma_{IN} = \Gamma_{PP},$$

(54)

$$\Gamma_{OUT} = \Gamma'_{LPP}.$$

(55)

25 Substituting Equations (52) and (54) into Equation (6) yields Equation (56) as follows:

$$\Gamma_{PP} = S_{11}^P + \frac{S_{12}^P S_{21}^P \Gamma_{LPP}}{1 - S_{22}^P \Gamma_{LPP}}.$$

(56)

Similarly, substituting Equations (53) and (55) into Equation (7) yields Equation (57) as follows:

$$\Gamma'_{LPP} = S_{22}^P + \frac{S_{12}^P S_{21}^P \Gamma'_{PP}}{1 - S_{11}^P \Gamma'_{PP}}.$$

(57)

5 Referring to FIG. 2, for the peak output matching network **136**, for high-efficiency operations:

$$\Gamma_L = \Gamma'_{LPOFF}.$$

(58)

$$\Gamma_S = \Gamma_{POFF},$$

10 (59)

$$\Gamma_{IN} = \Gamma'_{POFF},$$

(60)

$$\Gamma_{OUT} = \Gamma_{LPOFF},$$

(61)

15 Substituting Equations (58) and (60) into Equation (6) yields Equation (62) as follows:

$$\Gamma'_{POFF} = S_{11}^P + \frac{S_{12}^P S_{21}^P \Gamma'_{LPOFF}}{1 - S_{22}^P \Gamma'_{LPOFF}}.$$

(62)

20 Similarly, substituting Equations (59) and (61) into Equation (7) yields Equation (63) as follows:

$$\Gamma_{LPOFF} = S_{22}^M + \frac{S_{12}^M S_{21}^M \Gamma_{POFF}}{1 - S_{11}^M \Gamma_{POFF}}.$$

(63)

Subtracting Equation (62) from Equation (56) yields Equation (64) as follows:

$$\Gamma_{PP} - \Gamma'_{POFF} = S_{12}^P S_{21}^P \left(\frac{\Gamma_{LPP}}{1 - S_{22}^P \Gamma_{LPP}} - \frac{\Gamma'_{LPOFF}}{1 - S_{22}^P \Gamma'_{LPOFF}} \right).$$

25 (64)

Subtracting Equation (63) from Equation (57) yields Equation (65) as follows:

$$\Gamma'_{LPP} - \Gamma_{LPOFF} = S_{12}^P S_{21}^P \left(\frac{\Gamma'_{PP}}{1 - S_{11}^P \Gamma'_{PP}} - \frac{\Gamma_{OFF}}{1 - S_{11}^P \Gamma_{OFF}} \right).$$

(65)

Rearranging Equation (65) yields Equation (66) as follows:

$$S_{12}^M S_{21}^M = \frac{(\Gamma_{MP} - \Gamma_{ME})(1 - S_{22}^M \Gamma_{LMP})(1 - S_{22}^M \Gamma_{LME})}{\Gamma_{LMP} - \Gamma_{LME}}.$$

(66)

5 Substituting Equation (66) into Equation (56) and rearranging yields Equation (67) as follows:

$$S_{11}^P = \Gamma_{PP} - \frac{(\Gamma_{PP} - \Gamma'_{POFF})(1 - S_{22}^P \Gamma'_{LPOFF})\Gamma_{LPP}}{\Gamma_{LPP} - \Gamma'_{LPOFF}}.$$

(67)

Rearranging Equation (63) yields Equation (68) as follows:

$$10 \quad S_{22}^P = \Gamma_{LPOFF} - \frac{S_{21}^P S_{12}^P \Gamma_{POFF}}{1 - S_{11}^P \Gamma_{POFF}}.$$

(68)

Substituting Equations (66) and (67) into Equation (68) yields Equation (69) as follows:

$$S_{22}^P = \Gamma_{LPOFF} - \frac{(\Gamma_{PP} - \Gamma'_{POFF})(1 - S_{22}^P \Gamma_{LPP})(1 - S_{22}^P \Gamma'_{LPOFF})\Gamma_{POFF}}{(\Gamma_{LPP} - \Gamma'_{LPOFF})(1 - \Gamma_{PP} \Gamma_{POFF}) + (\Gamma_{PP} - \Gamma'_{POFF})(1 - S_{22}^P \Gamma'_{LPOFF})\Gamma_{LPP} \Gamma_{POFF}}.$$

15 (69)

Solving Equation (69) for the matrix parameter S_{22}^P yields Equation (70) as follows:

$$S_{22}^P = \frac{\Gamma_{PP} \Gamma_{POFF} |\Gamma_{LPOFF}|^2 - |\Gamma_{LPOFF}|^2 - \Gamma_{LPP} \Gamma_{LPOFF} |\Gamma_{POFF}|^2 + \Gamma_{LPP} \Gamma_{LPOFF} + |\Gamma_{POFF}|^2 - \Gamma_{PP} \Gamma_{POFF}}{\Gamma_{LPP} \Gamma_{POFF} \Gamma_{PP} |\Gamma_{LPOFF}|^2 - \Gamma_{LPP} |\Gamma_{POFF}|^2 |\Gamma_{LPOFF}|^2 + \Gamma_{LPP} - \Gamma'_{LPOFF} - \Gamma_{LPP} \Gamma_{PP} \Gamma_{POFF} + |\Gamma_{POFF}|^2 \Gamma'_{LPOFF}}$$

(70)

20 Once the matrix parameter S_{22}^P is calculated using Equation (70) in terms of the voltage reflection coefficients Γ_{PP} , Γ_{POFF} , Γ_{LPP} , and Γ_{LPOFF} given by Equations (48)-(51), and assuming that the network is reciprocal such that $S_{21}^P = S_{12}^P$, the remaining matrix parameters S_{11}^P , S_{12}^P , and S_{21}^P can be calculated using Equations (66) and (67).

25 Network Phase Delay

After determining the proper input power split between the main and peak branches and the S matrices for all five of the different matching networks in amplifier **100**, what

remains to be determined is the phase delay for each branch.

Contributions to the phase delay in the main branch **120** are from (i) the main input matching network **122** loaded by the input impedance of the main amplifier device **124** biased in Class-AB, (ii) the main device **124** itself, and (iii) the main output matching network **126** terminated by the main branch load impedance looking into the combining node **140** away from the main output matching network **126**, where the main branch load impedance is a function of the main device output power P_M , the peak device output power P_p , the combining node impedance Z_{node} , and the off-state peak load impedance Z_{LPOFF} .

Contributions to the phase delay in the peak branch **130** are from (i) the peak input matching network **132** loaded by the input impedance of the peak amplifier device **134** biased in Class-C, (ii) the peak device **134** itself, and (iii) the peak output matching network **136** terminated by the peak branch load impedance looking into the combining node **140** away from the peak output matching network **136**, where the peak branch load impedance is function of the main device output power P_M , the peak device output power P_p , the combining node impedance Z_{node} , and off-state peak load impedance Z_{LPOFF} .

In a typical application, the goal is to achieve a prescribed level of phase matching between the main and peak branches. Since there is no guarantee that the phase delays from the two branches will fulfill such prescribed condition, one of the two branches can be additionally delayed by means of inserting an input phase offset line (the function of which will be subsumed into the corresponding input matching network) or a phase shifter, or by means of digital signal processing in case of independent input to the main and peak branches. The phase delay contribution from amplifier devices (e.g., transistors) is measured during the load-pull process. If the S-parameters and load impedances are known, then the phase delay contribution from individual two-port networks characterized by S matrices can be calculated.

FIG. 3 shows a generic matching network **320** having (i) input port **315** connected to a powered input load **310** having impedance Z_S and (ii) output port **325** connected to a grounded output load **330** having impedance Z_L and voltage reflection coefficient Γ_L , where input load **310** is powered by power supply **305** applying complex voltage signal V_S . The input voltage reflection coefficient Γ_{IN} for matching network **320** is given by previous Equation (5), where S_{11} , S_{12} , S_{21} , and S_{22} are the coefficients of the S matrix for matching network **320**.

In general, a complex voltage wave V_n at a port n of a matching network is given by Equation (71) as follows:

$$V_n = V_n^+ + V_n^- \quad (71)$$

- 5 where V_n^+ is the voltage wave heading towards the matching network and incident on port n , and V_n^- is the voltage wave reflected from port n and heading away from the matching network. Matching network **320** has two ports: input port **315** at its upstream side and output port **325** at its downstream side.

The input voltage reflection coefficient Γ_{IN} is given by Equation (72) as follows:

$$10 \quad \Gamma_{IN} = \frac{V_1^-}{V_1^+}. \quad (72)$$

Similarly, the load voltage reflection coefficient Γ_L is given by Equation (73) as follows:

$$\Gamma_L = \frac{V_2^+}{V_2^-}. \quad (73)$$

- 15 Substituting Equation (72) into Equation (71) for Port 1 yields Equation (74) as follows:

$$V_1 = V_1^+ + V_1^- = V_1^+ (1 + \Gamma_{IN}). \quad (74)$$

Rearranging Equation (5) for impedance Z_{IN} yields Equation (75) as follows:

$$20 \quad Z_{IN} = Z_0 \frac{1 + \Gamma_{IN}}{1 - \Gamma_{IN}} \quad (75)$$

Substituting Equation (6) into Equation (75) yields Equation (76) as follows:

$$25 \quad Z_{IN} = Z_0 \frac{(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{12}S_{21}\Gamma_L}{(1 - S_{11})(1 - S_{22}\Gamma_L) - S_{12}S_{21}\Gamma_L} \quad (76)$$

The following Equation (77) represents the relationship between the voltage wave V_1 at Port 1 and the source voltage wave V_s generated by power supply **305** after substituting in Equation (76):

$$V_1 = \frac{Z_{IN}}{Z_{IN} + Z_S} V_S = \frac{Z_0 \left[(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L \right] V_S}{Z_0 \left[(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L \right] + Z_S \left[(1 - S_{11})(1 - S_{22}\Gamma_L) - S_{21}S_{12}\Gamma_L \right]} \quad (77)$$

Substituting Equation (6) into Equation (74) yields Equation (78) as follows:

$$V_1 = V_1^+ + V_1^- = V_1^+ (1 + \Gamma_{IN}) = V_1^+ \frac{(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L}{1 - S_{22}\Gamma_L}$$

5 (78)

Substituting V_1 from Equation (78) in place of V_1 in Equation (77) and solving for V_1^+ yields Equation (79a) as follows:

$$V_1^+ = \frac{Z_0 (1 - S_{22}\Gamma_L) V_S}{Z_0 \left[(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L \right] + Z_S \left[(1 - S_{11})(1 - S_{22}\Gamma_L) - S_{21}S_{12}\Gamma_L \right]} \quad (79a)$$

10 From the relationship $V_2^- = S_{21}V_1^+ + S_{22}V_2^+$ of Equation (1) and from the definition of the reflection coefficient $\Gamma_L = \frac{V_2^+}{V_2^-}$, we get Equation (79b) as follows:

$$V_2^- = \frac{S_{21}V_1^+}{1 - S_{22}\Gamma_L}.$$

(79b)

15 Substituting the expression for V_1^+ from the Equation (79a) into Equation (79b) yields Equation (80) as follows:

$$V_2^- = \frac{S_{21}V_1^+}{1 - S_{22}\Gamma_L} = \frac{Z_0 S_{21} V_S}{Z_0 \left[(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L \right] + Z_S \left[(1 - S_{11})(1 - S_{22}\Gamma_L) - S_{21}S_{12}\Gamma_L \right]} \quad (80)$$

Applying the definition of the reflection coefficient $\Gamma_L = \frac{V_2^+}{V_2^-}$ to Equation (80) yields

Equation (81) as follows:

$$20 \quad V_2^+ = \Gamma_L V_2^- = \frac{Z_0 S_{21} \Gamma_L V_S}{Z_0 \left[(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L \right] + Z_S \left[(1 - S_{11})(1 - S_{22}\Gamma_L) - S_{21}S_{12}\Gamma_L \right]} \quad (81)$$

Substituting Equations (80) and (81) into Equation (71) for Port 2 yields Equation (82) as follows:

$$V_2 = V_2^+ + V_2^- = \frac{Z_0 S_{21} (1 + \Gamma_L) V_s}{Z_0 [(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L] + Z_s [(1 - S_{11})(1 - S_{22}\Gamma_L) - S_{21}S_{12}\Gamma_L]} \quad (82)$$

Dividing Equation (82) by Equation (77) yields Equation (83) as follows:

$$\frac{V_2}{V_1} = \frac{S_{21} (1 + \Gamma_L)}{(1 + S_{11})(1 - S_{22}\Gamma_L) + S_{21}S_{12}\Gamma_L} = \frac{S_{21} (1 + \Gamma_L)}{1 + S_{11} - (S_{22} + S_{11}S_{22} - S_{21}S_{12})\Gamma_L} \quad (83)$$

wherein the complex ratio of voltages can be represented according to Equation (84) as follows:

$$\frac{V_2}{V_1} = \left| \frac{V_2}{V_1} \right| e^{j(\phi_2 - \phi_1)}$$

(84)

Where ϕ_1 is the phase of the voltage wave at Port 1 and ϕ_2 is the phase of the voltage wave at Port 2.

Substituting Equation (84) into Equation (83) yields Equation (85) as follows:

$$\left| \frac{V_2}{V_1} \right| e^{j(\phi_2 - \phi_1)} = \left| \frac{S_{21} (1 + \Gamma_L)}{1 + S_{11} - (S_{22} + S_{11}S_{22} - S_{21}S_{12})\Gamma_L} \right| e^{j\phi}$$

(85)

where the phase delay $\Delta\phi = \phi_2 - \phi_1 = \phi$ for matching network **320**. Since the S matrices of the five matching networks in amplifier **100** are known, Equation (85) can be used to determine the phase delay across each of those matching networks.

Design Technique for a Two-Way Doherty Amplifier

FIG. 4 shows a flow diagram of technique **400** for designing two-way Doherty amplifier **100** of FIG. 1.

In step **402** of design (i.e., synthesis) technique **400**, main and peak input matching networks **122** and **132**, and node matching network **150** are designed using the techniques described previously. Once the input power split that satisfies requirements for maximum power levels is determined, it remains fixed. The impedance for the maximum peak power should also remain fixed throughout the remainder of the design procedure.

The iterative loop formed by steps **404-410** is implemented to determine main and peak impedance values Z_{PP} , Z_{MP} , and Z_{ME} that satisfy the condition of step **408** that the node

impedance modulation ratio N_{comb} at the combining node **140** is substantially equal to the main device impedance modulation ratio N_{LP} between Z_{MP} and Z_{ME} , where:

- Z_{PP} is the impedance presented to the peak device **134** during high-power operations;
- Z_{MP} is the impedance presented to the main device **124** during high-power operations; and
- Z_{ME} is the impedance presented to the main device **124** during average-power, high-efficiency operations.

In particular, in step **404**, initial values for the three impedances Z_{PP} , Z_{MP} , and Z_{ME} are selected using the corresponding load-pull contours. These initial selections are made by educated guesses based on the device load-pull performance and the amplifier specifications. For example, if we need to design a 200W amplifier, we may start with (i) an impedance on the main device that has 100W capability and (ii) an impedance on the peak device that has 100W capability. There are multiple impedances that satisfy this power condition, but the resulting amplifier may substantially differ in gain and efficiency, which leads to an iterative process of further selection. The power ratio between the main and peak device may change, which will lead to further iterations in the selection process.

In step **406**, the node impedance modulation ratio N_{comb} and the main device impedance modulation ratio N_{LP} are calculated using Equations (2b) and (3), respectively.

In step **408**, it is determined whether the node impedance modulation ratio N_{comb} sufficiently matches the main device impedance ratio N_{LP} , e.g., to within a specified threshold percentage. If not, then processing continues to step **410**, where one or more of the three impedances Z_{PP} , Z_{MP} , and Z_{ME} are adjusted using the corresponding load-pull contours. The impedances are moved in the impedance space of the load-pull contours by means of user-controlled cursors. Moving a cursor in the corresponding load-pull contour plot will alter the value of the impedance and the associated load-pull data, which will cause the algorithm to reevaluate matching network S-parameter values, values of N_{comb} , N_{LP} , and all other parameters of the circuit that are dependent on these impedances and the transistor load-pull data associated with these impedances. Processing then returns to step **406** to determine the impedance modulation ratio N_{comb} and the main device impedance modulation ratio N_{LP} using the updated impedances.

When step **408** determines that the node impedance modulation ratio N_{comb} sufficiently matches the main device impedance modulation ratio N_{LP} , then processing

continues to step **412**, where the S matrices for the main and peak output matching networks **126** and **136**, the inter-branch power split (implemented by power splitter **110**), and the inter-branch phase delay are calculated based on the final values for the three impedances Z_{PP} , Z_{MP} , and Z_{ME} determined by steps **404-410**, using the techniques described previously.

5

Analysis of a Two-Way Doherty Amplifier

After two-way Doherty amplifier **100** of FIG. 1 has been designed, e.g., using design technique **400** of FIG. 4, appropriate sets of load-pull data can be used to analyze the amplifier

- 10 to establish relationships between the values P_{in}^M and Z_{in}^M on the input side and the values P_M , Z_M , and ϕ_M on the output side of the main device **124** and also between the values P_{in}^P and Z_{in}^P on input side and the values P_P , Z_P , and ϕ_P on the output side of the peak device **134**.

- 15 FIG. 5 shows a flow diagram of a technique **500** for analyzing two-way Doherty amplifier **100** of FIG. 1. Analysis technique **500** consists of two nested loops: an outer loop in which the amplifier is analyzed at different input power levels and an inner loop in which the impedance levels for the main and peak output matching networks are adjusted for a particular input power level until those impedance levels converge on steady-state values.

- In analysis technique **500**, the input power level starts at the maximum power level
 20 for the amplifier and is decremented for each iteration of the outer loop for a specified number of iteration steps designed to bring the input power level down to an appropriate minimum power level for the amplifier. Analysis technique **500** starts the input power sweep of the outer loop from the maximum power level because impedances and other parameters were selected during design technique **400** of FIG. 4 for this same maximum
 25 power level, which ensures that, in the absence of error in the design, analysis technique **500** will rapidly if not immediately converge to satisfy the inner loop condition of step **512** for the first iteration of the inner loop for the first iteration of the outer loop. In an alternative implementation of the analysis technique, the input power level could start at the minimum power level and be incremented for each subsequent iteration of the outer loop until the
 30 maximum power level is reached.

For the initial iteration of the inner loop and the initial iteration of the outer loop, the main and peak output matching network impedance levels Z_M and Z_P are initialized to high-power impedance levels. If the design is determined using design technique **400** of

FIG. 4, then the initial Z_M and Z_P values will be respectively equal to the final values of Z_{MP} and Z_{PP} from design technique **400**. If an external design is used (i.e., a design determined using some other technique), then educated guesses for the impedance values Z_{MP} and Z_{PP} are used to start the iterative process. For each subsequent iteration of the

5 outer loop, the steady-state main and peak output matching network impedance levels Z_M^{new} and Z_P^{new} determined during the previous outer-loop iteration are retained as the initial values for the first iteration of the inner loop.

In particular, analysis technique **500** begins at step **502**, where the input power level P_{in} is initialized to the maximum power level P_{inMax} . Based on the known power split

10 performed by input power splitter **110**, the magnitudes of the main branch input power level P_{IN}^M and the peak branch input power level P_{IN}^P can be determined from the input power level P_{in} . In addition, step **502** specifies the size P_{step} of each power level decrement and the number N_{step} of such decrements for the analysis. Note that, for this explanation, all powers are expressed in dBm or other suitable relative units.

15 In step **504**, the impedance level Z_M of main amplifier device **124** and the network impedance level Z_P of peak amplifier device **134** are initialized to values for high-power operations determined during design technique **400** of FIG. 4.

In addition, phase alignments for the main and peak branches are performed during step **504**. Equation (85) is used to calculate the phase delay of each block within each

20 branch under varying load conditions that they experience during the amplifier operation. The sum of the phase delays for each block in a branch will give the overall phase delay for the branch. Since there are two (or more) branches, and we want to make signals combine at the combining node under specified phase conditions (in-phase or otherwise specified phase relation), the phase of each peak branch may need to be adjusted with respect to the

25 main branch to achieve the specified phase conditions. For in-phase alignment, for example, if (i) the main branch has a delay of 97° and (ii) the peak branch has a delay of 85° , in order to make the currents in phase at the combining node **140**, the peak branch can be delayed by 12° by delaying the peak input signal by 12° . If the new delay for the main branch is now 95° and new delay for the peak branch (with the previous delay correction of

30 12°) is 98° (this can happen due to load conditions changing somewhat as a consequence of the phase adjustment), an additional delay correction of -3° can be applied to the peak branch (for a net delay correction of 9°), such that the delay for the main branch is now 96°

and the delay for the peak branch is now 96° , at which point phase alignment is completed. This is done directly by monitoring the branch currents at the combining node. Equation (83) is buried in the calculations that yield proper values for the branch currents at the combining node. In the phase-alignment process, Z_M and Z_P will also change somewhat
 5 but this is expected.

If the proper design impedances are not known, e.g., because the amplifier was designed using a technique other than design technique **400** of FIG. 4, then "phase alignment needs to be guessed as well and we need to go through iterations to achieve convergence and if necessary re-evaluated our phasing guess." Looking at the constant
 10 input power load-pull contours for the main and peak devices, the most plausible values for impedances Z_M and Z_P for high-power performance are determined. The phase offset needed for an in-phase condition is then determined by observing the initial phase mismatch of the currents at the combining node and using it to obtain convergence for this initial value of input power. The technique does not yet proceed to a full input power sweep. Changes
 15 are made in phase alignment if necessary and the convergence is repeated at the initial input power level. This is done until a desirable phase alignment is achieved. Only then does the technique proceed to the full input power sweep.

In step **506**, the output power P_M and phase response ϕ_M of main amplifier device **124** are determined from the load-pull data (e.g., P_{lpAB} , ϕ_{lpAB} for the main device biased in
 20 Class-AB) using the main branch input power level P_{IN}^M and the main amplifier device impedance level Z_M . The power and phase values are read from the load-pull power sweeps. These parameters are directly measured in the active device load-pull process with some level of interpolation possibly involved. Similarly, the output power P_P and phase response ϕ_P of peak amplifier device **134** are determined from the load-pull data (e.g., P_{lpDC} , ϕ_{lpDC} for
 25 the peak device biased in Class-C) using the peak branch input power level P_{IN}^P and the peak amplifier device impedance level Z_P .

In step **508**, the voltages V_M and V_P and currents I_M and I_P output from the main and peak amplifier devices **124** and **134** are determined.

FIG. 6 shows a block diagram representing passive output combining network **170** of
 30 FIG. 1. In FIG. 6, load **138** represents the load on the main branch contributed by the peak branch when the peak branch is disabled. It is the loading effect of the peak branch on the main branch when the peak device is in the off-state.

For the main branch **120** going from the main device **124** toward the combining node **140**, calculations for converting the main device impedance Z_M into the main voltage reflection coefficient Γ_M , and vice versa, are given by Equations (86) and (87) as follows:

$$\Gamma_M = \frac{Z_M - Z_0}{Z_M + Z_0} \quad (86)$$

$$Z_M = Z_0 \frac{1 + \Gamma_M}{1 - \Gamma_M} = \frac{V_M}{I_M} = |Z_M| e^{j\phi_{Z_M}} \quad (87)$$

The main device voltage V_M is calculated from the known main device power P_M and main device impedance Z_M (complex power S_M is fully determined by known P_M and Z_M) as follows. Complex power S_M of the main device has a real part P_M that is known from the load-pull data and an imaginary part Q_M that is unknown. However, S_M is also given by $\frac{|V_M|^2}{2Z'_M}$ in which the impedance Z_M is known from load-pull data. Known values of P_M and Z_M allow the calculation of V_M and $I_M = \frac{V_M}{Z_M}$, which are used in the circuit analysis of output combining network **170**. As such, the complex power S_M of the main device is given by Equation (88) as follows:

$$S_M = P_M + jQ_M = \frac{|V_M|^2}{2Z'_M} = \frac{|I_M|^2 Z_M}{2} = \frac{V_M I'_M}{2} \quad (88)$$

and the voltage V_M of the main device is given by Equation (89) as follows:

$$V_M = |V_M| e^{j\phi_M} = \sqrt{\frac{2P_M}{\text{Re}\{Z_M\}}} |Z_M| e^{j\phi_M} \quad (89)$$

where

ϕ_M is used as reference phase ($\phi_M = 0$) or measured

$$V_M = \sqrt{\frac{2P_M}{\text{Re}\{Z_M\}}} |Z_M|$$

For the peak branch **130** going from the peak device **134** toward the combining node **140**, calculations for converting the peak device impedance Z_p into the peak voltage reflection coefficient Γ_p , and vice versa, are given by Equations (90) and (91) as follows:

$$\Gamma_p = \frac{Z_p - Z_0}{Z_p + Z_0} \quad (90)$$

$$Z_p = Z_0 \frac{1 + \Gamma_p}{1 - \Gamma_p} = \frac{V_p}{I_p} = |Z_p| e^{j\phi_{Z_p}} \quad (91)$$

The peak device voltage V_p is calculated from the known peak device power P_p and peak device impedance Z_p (complex power S_p is fully determined by known P_p and Z_p) as follows. Complex power S_p of the peak device has a real part P_p that is known from the load-pull data and an imaginary part Q_p that is unknown. However, S_p is also given by $\frac{|V_p|^2}{2Z'_p}$ in which the impedance Z_p is known from load-pull data. Known values of P_p and Z_p allow the calculation of V_p and $I_p = \frac{V_p}{Z_p}$, which are used in the circuit analysis of output combining network **170**. As such, the complex power S_p of the peak device is given by Equation (92) as follows:

$$S_p = P_p + jQ_p = \frac{|V_p|^2}{2Z'_p} = \frac{|I_p|^2 Z_p}{2} = \frac{V_p I_p'}{2} \quad (92)$$

and the voltage V_p of the peak device is given by Equation (93) as follows:

$$V_p = |V_p| e^{j\phi_p} = \sqrt{\frac{2P_p}{\text{Re}\{Z_p\}}} |Z_p| e^{j\phi_p} \quad (93)$$

Once the voltages and currents on the device side for each branch are known, currents on the node side of each branch can be determined, which enables the calculation of loading impedances for each branch and in turn enable the calculation of new impedances presented to the devices. In particular, in step **510**, the signals are allowed to propagate through the passive network formed by the main and peak output matching networks **126**

and **136**, the node matching network **150**, and output load **160**, and new values Z_M^{new} and Z_P^{new} for the main and peak amplifier device impedance levels are determined.

Load side main voltages, currents, and impedances are calculated from known main device side voltages, currents, impedances, and S-parameters of the main output matching network **126** as follows. Since V_M , I_M , Z_M , and Γ_M are known on the device side of main output matching network **126** and S-parameters $[S^M]$ of the network **126** are known as well, V_{LM} , I_{LLM} , Z_{LLM} , and Γ_{LLM} can be calculated on the node side of network **126** by using the expressions below, which result from circuit analysis. Calculations regarding Z_{LOFF} are done to account for loading effect at combining node **140** due to the off-state impedance of the peak device transformed through network **126**.

The relation between Γ_M and Γ_{LLM} is derived from the definition of the S-parameters (Fig. 2) and given by Equation (94) as follows:

$$\Gamma_M = S_{11}^M + \frac{S_{12}^M S_{21}^M \Gamma_{LLM}}{1 - S_{22}^M \Gamma_{LLM}}$$

(94)

Rearranging Equation (94) to express Γ_{LLM} in terms of Γ_M yields Equation (95) as follows:

$$\Gamma_{LLM} = \frac{\Gamma_M - S_{11}^M}{S_{12}^M S_{21}^M + S_{22}^M (\Gamma_M - S_{11}^M)}$$

(95)

where the corresponding impedance Z_{LLM} is given by Equation (96) as follows:

$$Z_{LLM} = Z_0 \frac{1 + \Gamma_{LLM}}{1 - \Gamma_{LLM}}$$

(96)

Using Equation (83), V_{LM} can be expressed in terms of V_M , and used to calculate current I_{LLM} according to Equations (97) and (98) as follows:

$$V_{LM} = \frac{S_{21}^M (1 + \Gamma_{LLM}) V_M}{1 + S_{11}^M - (S_{22}^M + S_{11}^M S_{22}^M - S_{12}^M S_{21}^M) \Gamma_{LLM}}$$

(97)

$$I_{LLM} = \frac{V_{LM}}{Z_{LLM}}$$

(98)

From the peak device side, off-state impedance Z_{OFF} of the peak device is transformed into Z_{LOFF} loading the main branch as follows:

$$\begin{aligned} Z_{OFF} &= Z_0 \frac{1 + \Gamma_{OFF}}{1 - \Gamma_{OFF}} & \Gamma_{OFF} &= \frac{Z_{OFF} - Z_0}{Z_{OFF} + Z_0} \\ \Gamma_{LOFF} &= S_{22}^P + \frac{S_{12}^P S_{21}^P \Gamma_{OFF}}{1 - S_{11}^P \Gamma_{OFF}} & Z_{LOFF} &= Z_0 \frac{1 + \Gamma_{LOFF}}{1 - \Gamma_{LOFF}} \end{aligned}$$

The main branch load impedance Z_{LM} is expressed in terms of Z_{LLM} and Z_{LOFF} , where Z_{LLM} is given by a parallel connection of Z_{LM} and Z_{LOFF} . The main branch load current I_{LM} entering the combining node is derived from the current I_{LLM} entering the current divider formed by Z_{LM} and Z_{LOFF} as follows:

$$Z_{LM} = \frac{Z_{LLM} Z_{LOFF}}{Z_{LOFF} - Z_{LLM}}; \quad I_{LM} = \frac{Z_{LOFF} - Z_{LLM}}{Z_{LOFF}} I_{LLM}$$

Load-side peak voltages, currents, and impedances are calculated from known peak device side voltages, currents, impedances, and S-parameters of the peak output matching network **136** as follows. Since V_P , I_P , Z_P , and Γ_P are known on the device side of peak output matching network **136** and S-parameters $[S^P]$ of the network **136** are known, V_{LP} , I_{LP} , Z_{LP} , and Γ_{LP} can be calculated on the node side of network **136** by using the expressions below, which result from circuit analysis. The manner in which peak expressions are derived is similar to that used for the main branch expression derivations presented above. The Z_{node} calculation is the result of an impedance transformation through a network with known S-parameters.

$$\begin{aligned} \Gamma_P &= S_{11}^P + \frac{S_{12}^P S_{21}^P \Gamma_{LP}}{1 - S_{22}^P \Gamma_{LP}} \Rightarrow \Gamma_{LP} = \frac{\Gamma_P - S_{11}^P}{S_{12}^P S_{21}^P + S_{22}^P (\Gamma_P - S_{11}^P)}; & Z_{LP} &= Z_0 \frac{1 + \Gamma_{LP}}{1 - \Gamma_{LP}} \\ V_{LP} &= \frac{S_{21}^P (1 + \Gamma_{LP}) V_P}{1 + S_{11}^P - (S_{22}^P + S_{11}^P S_{22}^P - S_{12}^P S_{21}^P) \Gamma_{LP}}; & I_{LP} &= \frac{V_{LP}}{Z_{LP}} \\ \Gamma_L &= \frac{Z_L - Z_0}{Z_L + Z_0}; & \Gamma_{node} &= S_{11}^C + \frac{S_{12}^C S_{21}^C \Gamma_L}{1 - S_{22}^C \Gamma_L}; & Z_{node} &= Z_0 \frac{1 + \Gamma_{node}}{1 - \Gamma_{node}} \end{aligned}$$

New main and peak branch load impedances Z_{LM} , Z_{LLM} , and Z_{LP} are calculated using the newly calculated values of I_{LM} , I_{LP} as follows:

$$V = (I_{LM} + I_{LP})Z_{node}; \quad Z_{LM} = \frac{V}{I_{LM}}; \quad Z_{LP} = \frac{V}{I_{LP}}$$

$$Z_{LLM} = \frac{Z_{LM}Z_{LOFF}}{Z_{LM} + Z_{LOFF}}; \quad \Gamma_{LLM} = \frac{Z_{LLM} - Z_0}{Z_{LLM} + Z_0};$$

- New main and peak device side impedances Z_M and Z_P are calculated based on the new main and peak branch load impedances Z_{LLM} and Z_{LLP} by transforming these
- 5 impedances through networks **126** and **136** back to the main and peak device side to obtain new device-side impedances Z_M and Z_P , respectively.

$$\Gamma_M = S_{11}^M + \frac{S_{12}^M S_{21}^M \Gamma_{LLM}}{1 - S_{22}^M \Gamma_{LLM}}; \quad Z_M = Z_0 \frac{1 + \Gamma_M}{1 - \Gamma_M}$$

$$\Gamma_{LP} = \frac{Z_{LP} - Z_0}{Z_{LP} + Z_0}; \quad \Gamma_P = S_{11}^P + \frac{S_{12}^P S_{21}^P \Gamma_{LLP}}{1 - S_{22}^P \Gamma_{LLP}}; \quad Z_P = Z_0 \frac{1 + \Gamma_P}{1 - \Gamma_P}$$

- In step **512**, it is determined whether the new main and peak amplifier device
- 10 impedance levels Z_M^{new} and Z_P^{new} sufficiently match the corresponding previous impedance levels Z_M and Z_P . In one implementation, this determination is made by determining whether the corresponding values are equal to within a specified threshold level. If the different pairs of impedance levels do not all sufficiently match, then the inner loop is not yet complete and processing continues to step **514**, where the main and peak amplifier
- 15 device impedance levels Z_M and Z_P are updated to be equal to the new values Z_M^{new} and Z_P^{new} determined in step **510**. Processing then returns to repeat steps **506-512** using the updated impedance levels.

- If step **512** determines that the different pairs of impedance levels do all sufficiently match, then the inner loop is complete for the current input power level P_{in} , and processing
- 20 continues to step **516**, which determines whether the number N_{steps} of remaining steps is greater than zero. If the number of steps is greater than zero, then the outer loop is not yet complete, and processing continues to step **518**, where the number of steps and the main and peak branch input power levels are decremented for the next iteration of the outer loop. Processing then returns to repeat steps **506-512** for the first iteration of the inner loop for the
- 25 new outer-loop iteration.

If step **516** determines that the number N_{steps} of steps has reached zero, then the analysis algorithm is complete and processing terminates at step **520**.

Note that Doherty amplifiers designed using design technique **400** of FIG. 4 can be analyzed using analysis technique **500** of FIG. 5 and/or using any other suitable analysis

technique. Similarly, analysis technique **500** can be used to analyze Doherty amplifiers designed using design technique **400** and/or Doherty amplifiers designed using any other suitable design technique.

Although design technique **400** and analysis technique **500** have been described in the context of two-way Doherty amplifiers, in general those techniques can be extended to apply to N -way Doherty amplifiers having a main amplifier branch and $(N-1)$ peak amplifier branches.

Although design technique **400** and analysis technique **500** have been described in the context of fixed input conditioning, those techniques can be applied to other implementations, such as static adjustable input conditioning and dynamic input conditioning. Static adjustable input conditioning implies that the amplitude ratio of the input signals and their phase relationship are adjusted for one power level at a frequency of interest. The user can specify change of input settings with frequency. Dynamic adjustable input conditioning implies that the amplitude ratio of the input signals and their phase relationship are specified for all power levels and frequencies of interest. The user can specify change of input settings with power and frequency. Each of these three different scenarios has its own set of goals and restrictions, and they can all be addressed using the principles and calculations of design technique **400** and analysis technique **500**.

While this invention has been described with reference to illustrative embodiments, this description is not intended to be construed in a limiting sense.

Various modifications of the described embodiments, as well as other embodiments of the invention, which are apparent to persons skilled in the art to which the invention pertains are deemed to lie within the principle and scope of the invention as expressed in the following claims.

Signals and corresponding nodes or ports may be referred to by the same name and are interchangeable for purposes here.

Transistors are typically shown as single devices for illustrative purposes. However, it is understood by those with skill in the art that transistors will have various sizes (e.g., gate width and length) and characteristics (e.g., threshold voltage, gain, etc.) and may consist of multiple transistors coupled in parallel to get desired electrical characteristics from the combination. Further, the illustrated transistors may be composite transistors.

Unless explicitly stated otherwise, each numerical value and range should be interpreted as being approximate as if the word "about" or "approximately" preceded the value of the value or range.

It will be further understood that various changes in the details, materials, and arrangements of the parts which have been described and illustrated in order to explain the nature of this invention may be made by those skilled in the art without departing from the scope of the invention as expressed in the following claims.

5 The use of figure numbers and/or figure reference labels in the claims is intended to identify one or more possible embodiments of the claimed subject matter in order to facilitate the interpretation of the claims. Such use is not to be construed as necessarily limiting the scope of those claims to the embodiments shown in the corresponding figures.

10 Although the elements in the following method claims, if any, are recited in a particular sequence with corresponding labeling, unless the claim recitations otherwise imply a particular sequence for implementing some or all of those elements, those elements are not necessarily intended to be limited to being implemented in that particular sequence.

15 Reference herein to "one embodiment" or "an embodiment" means that a particular feature, structure, or characteristic described in connection with the embodiment can be included in at least one embodiment of the invention. The appearances of the phrase "in one embodiment" in various places in the specification are not necessarily all referring to the same embodiment, nor are separate or alternative embodiments necessarily mutually exclusive of other embodiments. The same applies to the term "implementation."

20 Also for purposes of this description, the terms "couple," "coupling," "coupled," "connect," "connecting," or "connected" refer to any manner known in the art or later developed in which energy is allowed to be transferred between two or more elements, and the interposition of one or more additional elements is contemplated, although not required. Conversely, the terms "directly coupled," "directly connected," etc., imply the absence of such additional elements.

25 The description and drawings merely illustrate the principles of the invention. It will thus be appreciated that those of ordinary skill in the art will be able to devise various arrangements that, although not explicitly described or shown herein, embody the principles of the invention and are included within its spirit and scope. Furthermore, all examples recited herein are principally intended expressly to be only for pedagogical purposes to aid
30 the reader in understanding the principles of the invention and the concepts contributed by the inventor(s) to furthering the art, and are to be construed as being without limitation to such specifically recited examples and conditions. Moreover, all statements herein reciting principles, aspects, and embodiments of the invention, as well as specific examples thereof, are intended to encompass equivalents thereof.

CLAIMS

What is claimed is:

1. A technique for analyzing an amplifier having a main amplifier branch and at least one peak amplifier branch, each branch having an active device, the technique comprising:

- 5 (a) specifying an input power level and impedance levels for the amplifier;
(b) obtaining output power level and phase response of each active device using load-pull data based on the input power level and the impedance levels; and
(c) analyzing performance of the amplifier based on the impedance levels, the output power levels, and the phase responses.

10

2. The invention of claim 1, wherein the amplifier is a Doherty amplifier.

3. The invention of claim 1, wherein step (c) comprises determining an output voltage level for each active device.

15

4. The invention of claim 1, further comprising:

(d) determining new values for the impedance levels based on the output voltage levels of the active devices; and

(e) repeating steps (b) and (c) based on the new impedance level values.

20

5. The invention of claim 4, wherein steps (d) and (e) are repeated until the new impedance level values are substantially equal to corresponding previous impedance level values.

25 6. The invention of claim 1, wherein steps (a)-(c) are repeated for one or more additional input power levels.

7. The invention of claim 1, wherein the load-pull data comprises:

load-pull data for the active devices in the main and peak branches for a high-power
30 operating mode of the amplifier; and

load-pull data for only the active device in the main branch for a high-efficiency operating mode of the amplifier.

8. The invention of claim 1, wherein the load-pull data comprises:

Class-AB amplifier load-pull data for the active device in the main branch; and
Class-C amplifier load-pull data for the active device in each peak branch.

9. The invention of claim 1, wherein:

5 step (c) comprises determining an output voltage level for each active device;
further comprising:

(d) determining new values for the impedance levels based on the output voltage
levels of the active devices; and

(e) repeating steps (b) and (c) based on the new impedance level values;

10 steps (d) and (e) are repeated until the new impedance level values are substantially
equal to corresponding previous impedance level values;

steps (a)-(c) are repeated for one or more additional input power levels; and
the load-pull data comprises:

Class-AB amplifier load-pull data for the active device in the main branch for a high-
15 power operating mode of the amplifier;

Class-C amplifier load-pull data for the active device in the peak branch for the high-
power operating mode of the amplifier; and

Class-AB amplifier load-pull data for only the active device in the main branch for a
high-efficiency operating mode of the amplifier.

20

10. The invention of claim 1, wherein the amplifier is designed based on the load-pull
data for the active devices by:

(1) obtaining impedance levels for the amplifier from the load-pull data for the active
devices;

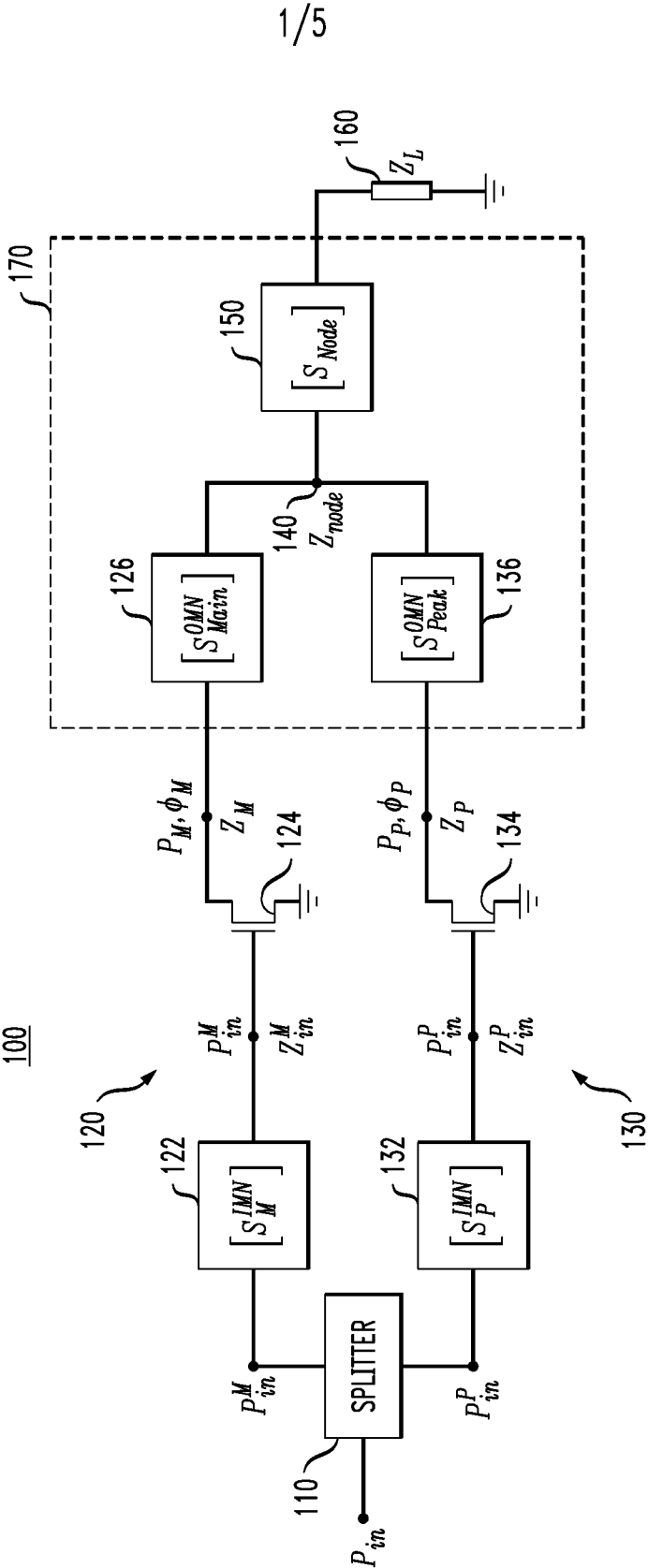
25 (2) determining a combiner impedance modulation ratio (e.g., N_{comb}) for the amplifier;

(3) determining a main device impedance modulation ratio (e.g., N_{LP}) for the amplifier
based on the impedance levels;

(4) determining whether the combiner impedance modulation ratio and the main device
impedance modulation ratio satisfy a specified condition; and

30 (5) repeating steps (2)-(4) using adjusted impedance levels until the combiner impedance
modulation ratio and the main device impedance modulation ratio satisfy the specified
condition to determine final impedance levels for the amplifier.

FIG. 1



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FIG. 2

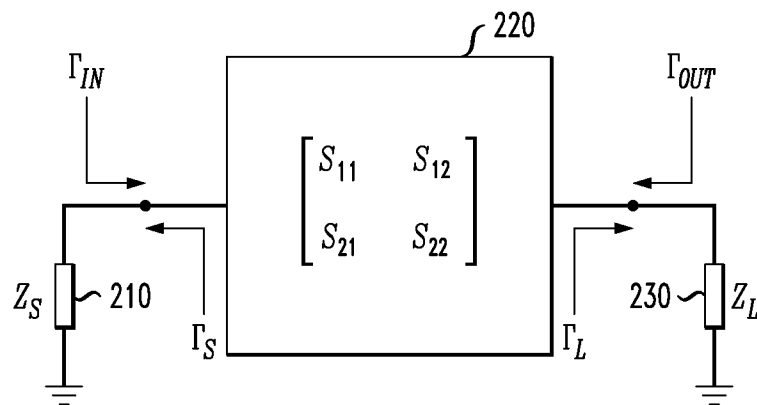
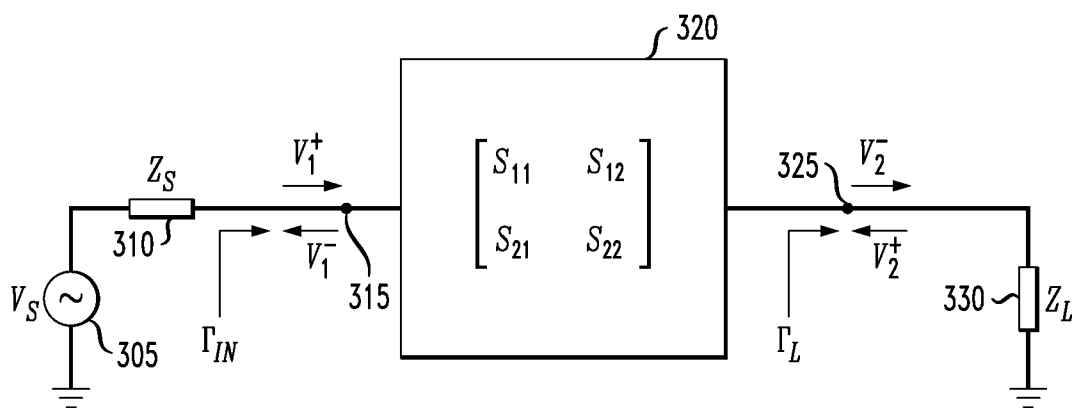
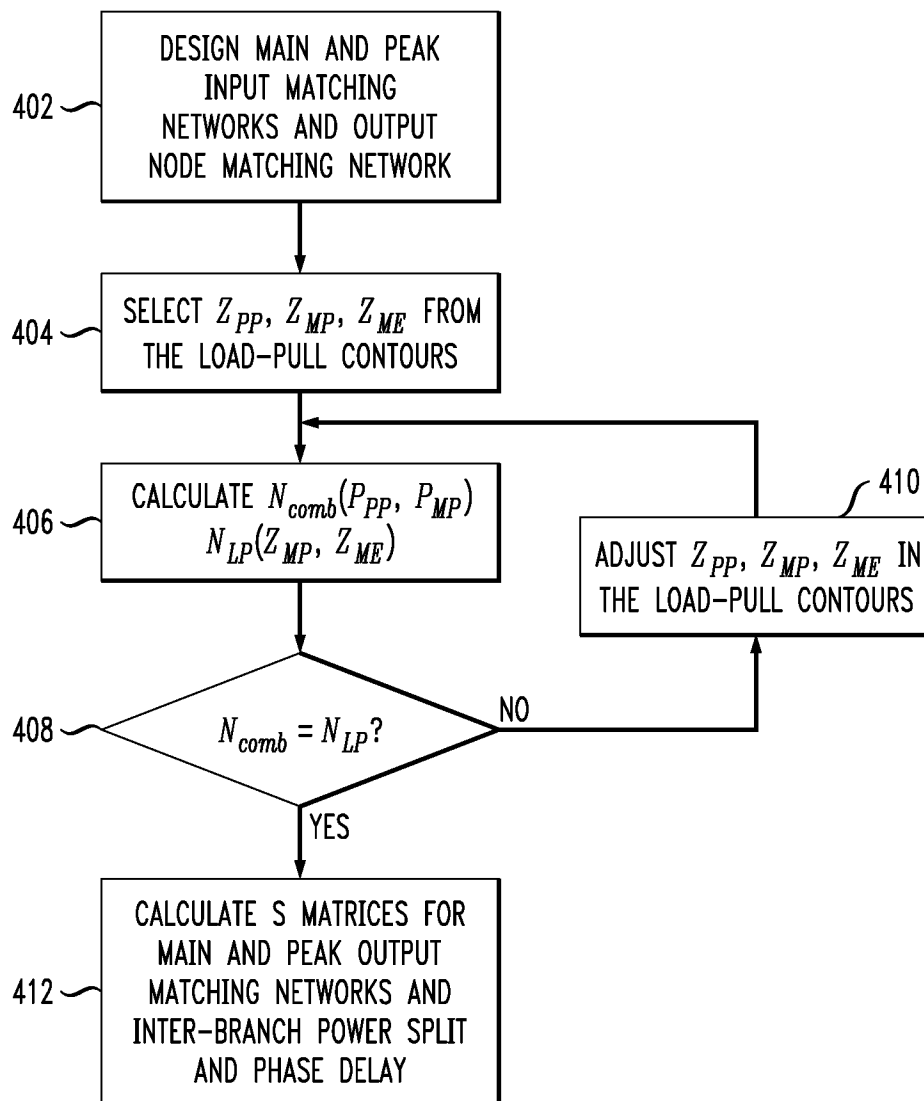


FIG. 3



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FIG. 4



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FIG. 5

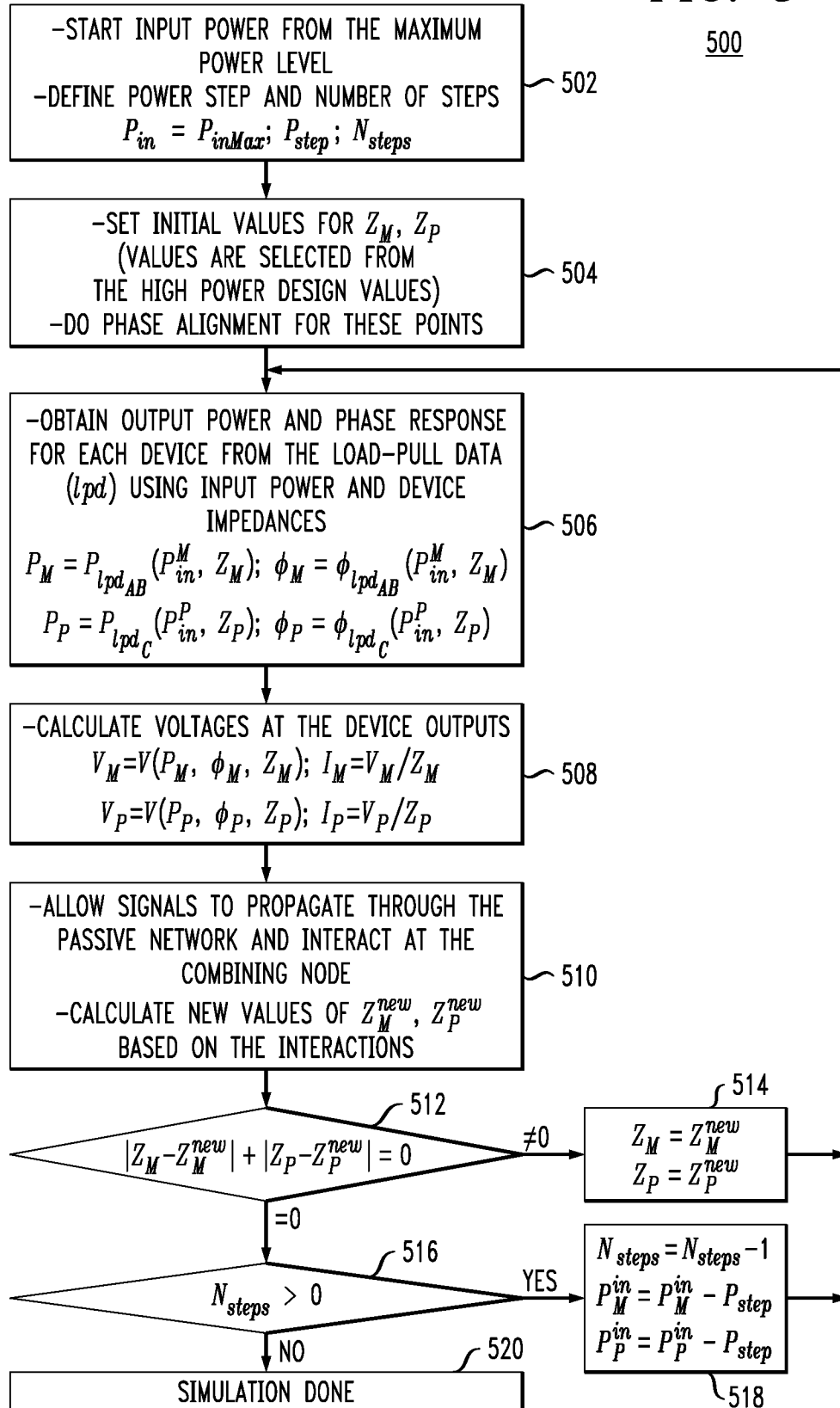
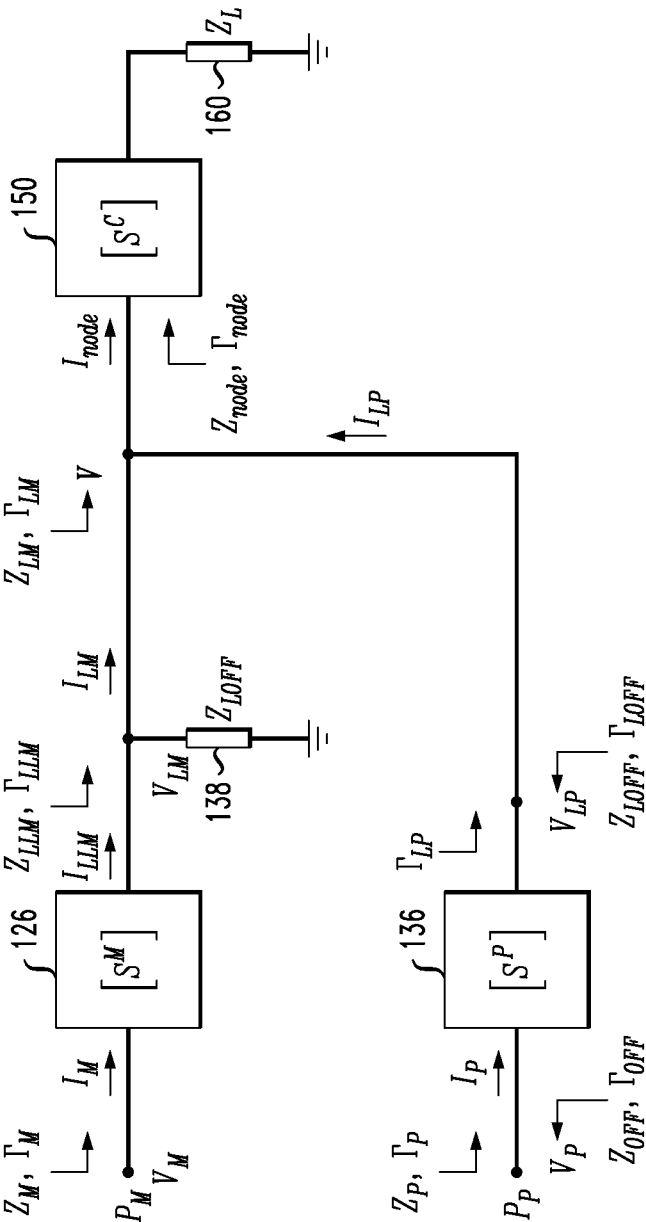


FIG. 6
170



INTERNATIONAL SEARCH REPORT

International application No.
PCT/CA2013/050927

A. CLASSIFICATION OF SUBJECT MATTER IPC: G01R 31/3163 (2006.01) , H03F 1/07 (2006.01) According to International Patent Classification (IPC) or to both national classification and IPC																	
B. FIELDS SEARCHED Minimum documentation searched (classification system followed by classification symbols) IPC: G01R 31/3163 (2006.01) , H03F 1/07 (2006.01) (In combination with keywords) Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched Electronic database(s) consulted during the international search (name of database(s), where practicable, search terms used) EPOQUE (Epodoc, English FullText) and Canadian Patent Database and USPTO WEST Keywords: Doherty, amplifier, input power, input impedance, phase, phase response, output power, and output voltage																	
C. DOCUMENTS CONSIDERED TO BE RELEVANT <table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 10%;">Category*</th> <th style="width: 60%;">Citation of document, with indication, where appropriate, of the relevant passages</th> <th style="width: 30%;">Relevant to claim No.</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">A</td> <td>HAMMI et al. Design and Performance Analysis of Mismatched Doherty Amplifiers Using an Accurate Load-Pull-Based Model, IEEE TRANSACTIONS ON MICROWAVE THEORY AND TECHNIQUES, August 2006, Vol. 54, No. 8, Pages 3246-3254 *whole document*</td> <td style="text-align: center;">1-10</td> </tr> <tr> <td style="text-align: center;">A</td> <td>DARRAJI et al. Generic load-pull-based design methodology for performance optimisation of Doherty amplifiers, IET Sci. Meas. Technol., 2012, Vol. 6, Iss. 3, pp. 132-138 *whole document*</td> <td style="text-align: center;">1-10</td> </tr> <tr> <td style="text-align: center;">A</td> <td>COLANTONIO et al. The Doherty Power Amplifier, INTERNATIONAL JOURNAL OF MICROWAVE AND OPTICAL TECHNOLOGY, November 2010, Vol. 5, No. 6, Pages 419-430 *whole document*</td> <td style="text-align: center;">1-10</td> </tr> <tr> <td style="text-align: center;">A</td> <td>RAWAT, Karun. Load-Pull Assisted CAD Design Of Inverted Doherty Amplifier Without Quarter-wave Transformer, 25th IEEE Canadian Conference on Electrical and Computer Engineering (CCECE), 2012 *whole document</td> <td style="text-align: center;">1-10</td> </tr> </tbody> </table>			Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.	A	HAMMI et al. Design and Performance Analysis of Mismatched Doherty Amplifiers Using an Accurate Load-Pull-Based Model, IEEE TRANSACTIONS ON MICROWAVE THEORY AND TECHNIQUES, August 2006, Vol. 54, No. 8, Pages 3246-3254 *whole document*	1-10	A	DARRAJI et al. Generic load-pull-based design methodology for performance optimisation of Doherty amplifiers, IET Sci. Meas. Technol., 2012, Vol. 6, Iss. 3, pp. 132-138 *whole document*	1-10	A	COLANTONIO et al. The Doherty Power Amplifier, INTERNATIONAL JOURNAL OF MICROWAVE AND OPTICAL TECHNOLOGY, November 2010, Vol. 5, No. 6, Pages 419-430 *whole document*	1-10	A	RAWAT, Karun. Load-Pull Assisted CAD Design Of Inverted Doherty Amplifier Without Quarter-wave Transformer, 25th IEEE Canadian Conference on Electrical and Computer Engineering (CCECE), 2012 *whole document	1-10
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A	RAWAT, Karun. Load-Pull Assisted CAD Design Of Inverted Doherty Amplifier Without Quarter-wave Transformer, 25th IEEE Canadian Conference on Electrical and Computer Engineering (CCECE), 2012 *whole document	1-10															
☐ Further documents are listed in the continuation of Box C. ☐ See patent family annex.																	
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Date of the actual completion of the international search February 24, 2014 (24-02-2014)		Date of mailing of the international search report 03 March 2014 (03-03-2014)															
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